

MOSFET

OptiMOS™ 3 Power-Transistor, 40 V

Features

- Dual N-channel, logic level
- Very low on-resistance R_{DS(on)}
 Superior thermal resistance
- 100% avalanche tested
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21

Product validation

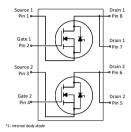
Qualified according to JEDEC Standard

Table 1 **Key Performance Parameters**

Parameter	Value	Unit
V_{DS}	40	V
$R_{\rm DS(on),max}$	17	mΩ
I _D	9.6	А
$Q_{ m oss}$	7.8	nC
Q_{G}	6.0	nC











Type/Ordering Code	Package	Marking	Related Links
ISA170170N04LMDS	PG-DSO-8	1717N04L	-

Public

OptiMOS™ 3 Power-Transistor, 40 V ISA170170N04LMDS



Table of Contents

Description	1
Maximum ratings	3
Thermal characteristics	4
Electrical characteristics	
Electrical characteristics diagrams	7
Package Outlines	11
Revision History	12
Trademarks	12
Disclaimer	12

OptiMOS™ 3 Power-Transistor, 40 V ISA170170N04LMDS



1 Maximum ratings

at T_{Δ} =25 °C, unless otherwise specified

Table 2 Maximum ratings

Parameter	Symbol	Values			Unit	Note / Test Condition	
Parameter	Syllibol	Min.	Тур.	Мах.	Ullit	Note/ Test Condition	
Continuous drain current ¹⁾	I _D	-	-	9.6 6.1 5.2 7.2	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =4.5 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =90 °C/W ²⁾	
Pulsed drain current ³⁾	I _{D,pulse}	-	-	38	А	<i>T_C</i> =25 °C	
Avalanche energy, single pulse ⁴⁾	E _{AS}	-	-	36	mJ	$I_{\rm D}$ =9.6 A, $R_{\rm GS}$ =25 Ω	
Gate source voltage	V_{GS}	-20	-	20	V	-	
Power dissipation	P _{tot}	-	-	2.5 1.4	W	$T_{\rm C}$ =25 °C $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =90 °C/W ²⁾	
Operating and storage temperature	$T_{\rm j},T_{\rm stg}$	-55	-	150	°C	-	

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

²⁾ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 μm thick) copper area for drain connection. PCB is vertical in still air.

³⁾ See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information

OptiMOS™ 3 Power-Transistor, 40 V ISA170170N04LMDS



2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Nieto/Test Condition
Parameter	Symbol	Min.	Тур.	Мах.	Offic	Note/ Test Condition
Thermal resistance, junction - solder point	R_{thJC}	-	-	50	°C/W	-
Thermal resistance, junction - ambient, 6 cm ² cooling area ⁵⁾	$R_{ m thJA}$	-	-	90	°C/W	-
Thermal resistance, junction - ambient, minimum footprint	R_{thJA}	-	-	150	°C/W	-

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain connection. PCB is vertical in still air.

OptiMOS™ 3 Power-Transistor, 40 V ISA170170N04LMDS



3 Electrical characteristics

at T_i =25 °C, unless otherwise specified

Table 4 Static characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition	
raiailletei	Syllibol	Min.	Тур.	Мах.	Ollic	Note/ Test Condition	
Drain-source breakdown voltage	$V_{(BR)DSS}$	40	-	-	V	$V_{\rm GS}$ =0 V, $I_{\rm D}$ =1 mA	
Gate threshold voltage	$V_{\rm GS(th)}$	1.1	-	2.7	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 1000 \mu \text{A}$	
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μΑ	$V_{\rm DS}$ =40 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =25 °C $V_{\rm DS}$ =40 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =125 °C	
Gate-source leakage current	I_{GSS}	-	10	100	nA	$V_{\rm GS}$ =20 V, $V_{\rm DS}$ =0 V	
Drain-source on-state resistance	$R_{\mathrm{DS(on)}}$	-	13 18	17 23.6	mΩ	$V_{\rm GS}$ =10 V, $I_{\rm D}$ =9.6 A $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =8.5 A	
Gate resistance	R_{G}	-	1.1	-	Ω	-	
Transconductance ⁶⁾	g_{fs}	12	25	-	S	$ V_{\rm DS} \ge 2 I_{\rm D} R_{\rm DS(on)max}, I_{\rm D} = 9.6 \mathrm{A}$	

⁶⁾ Defined by design. Not subject to production test.

Table 5 Dynamic characteristics

Darameter	Symbol	Values			Unit	Note/ Test Condition	
Parameter	meter Symbol		Тур.	Мах.	Offic	Note/ Test Condition	
Input capacitance ⁷⁾	C _{iss}	-	880	1100	pF	V _{GS} =0 V, V _{DS} =20 V, <i>f</i> =1 MHz	
Output capacitance ⁷⁾	Coss	-	220	290	pF	V _{GS} =0 V, V _{DS} =20 V, <i>f</i> =1 MHz	
Reverse transfer capacitance ⁷⁾	C _{rss}	-	15	26	pF	V _{GS} =0 V, V _{DS} =20 V, <i>f</i> =1 MHz	
Turn-on delay time	$t_{d(on)}$	-	6.7	-	ns	$V_{\rm DD}$ =20 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =9.6 A, $R_{\rm G,ext}$ =1.6 Ω	
Rise time	t _r	-	5.0	-	ns	$V_{\rm DD}$ =20 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =9.6 A, $R_{\rm G,ext}$ =1.6 Ω	
Turn-off delay time	$t_{ m d(off)}$	-	4.6	-	ns	$V_{\rm DD}$ =20 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =9.6 A, $R_{\rm G,ext}$ =1.6 Ω	
Fall time	t_{f}	-	4.0	-	ns	$V_{\rm DD}$ =20 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =9.6 A, $R_{\rm G,ext}$ =1.6 Ω	

 $^{^{7)}}$ Defined by design. Not subject to production test.

OptiMOS™ 3 Power-Transistor, 40 V ISA170170N04LMDS



Table 6 Gate charge characteristics 8)

Parameter	Symbol	Values			Unit	Note / Test Condition	
raiailletei	Symbol	Min.	Тур.	Мах.	Oilit	Note/ Test Condition	
Gate to source charge	$Q_{ m gs}$	-	2.7	-	nC	$V_{\rm DD}$ =20 V, $I_{\rm D}$ =9.6 A, $V_{\rm GS}$ =0 to 4.5 V	
Gate charge at threshold	$Q_{\mathrm{g(th)}}$	-	1.5	-	nC	$V_{\rm DD}$ =20 V, $I_{\rm D}$ =9.6 A, $V_{\rm GS}$ =0 to 4.5 V	
Gate to drain charge	$Q_{ m gd}$	-	1.6	-	nC	$V_{\rm DD}$ =20 V, $I_{\rm D}$ =9.6 A, $V_{\rm GS}$ =0 to 4.5 V	
Switching charge	Q_{sw}	-	2.8	-	nC	$V_{\rm DD}$ =20 V, $I_{\rm D}$ =9.6 A, $V_{\rm GS}$ =0 to 4.5 V	
Gate charge total ⁹⁾	Q_{g}	-	6.0	9.0	nC	$V_{\rm DD}$ =20 V, $I_{\rm D}$ =9.6 A, $V_{\rm GS}$ =0 to 4.5 V	
Gate plateau voltage	$V_{ m plateau}$	-	3.1	-	V	$V_{\rm DD}$ =20 V, $I_{\rm D}$ =9.6 A, $V_{\rm GS}$ =0 to 4.5 V	
Gate charge total ⁹⁾	$Q_{ m g}$	-	13	19.5	nC	$V_{\rm DD}$ =20 V, $I_{\rm D}$ =9.6 A, $V_{\rm GS}$ =0 to 10 V	
Output charge	Q _{oss}	-	7.8	-	nC	V _{DS} =20 V, V _{GS} =0 V	

⁸⁾ See "Gate charge waveforms" for parameter definition

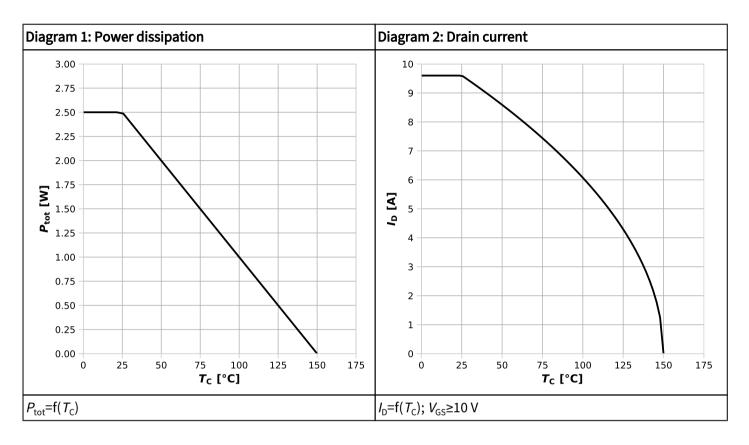
Table 7 Reverse diode

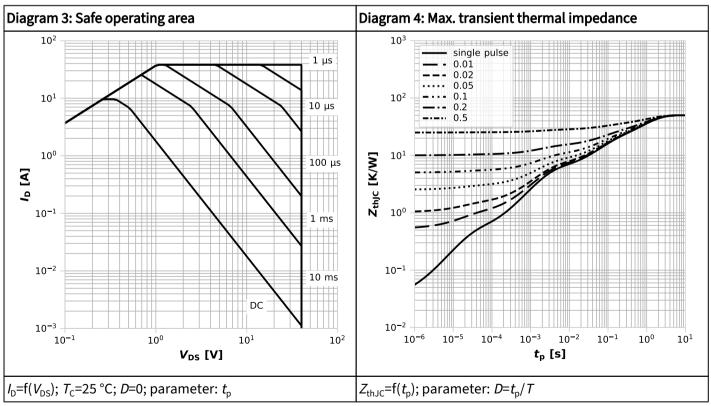
Parameter	Symbol	Values			Unit	Note / Test Candition	
raiailletei	Symbol	Min.	Тур.	Мах.	Ollic	Note/ Test Condition	
Diode continuous forward current	Is	-	-	3.1	А	<i>T</i> _C =25 °C	
Diode pulse current	I _{S,pulse}	-	-	38	А	<i>T</i> _c =25 °C	
Diode forward voltage	$V_{\rm SD}$	-	0.86	1.0	V	$V_{\rm GS}$ =0 V, $I_{\rm F}$ =9.6 A, $T_{\rm j}$ =25 °C	
Reverse recovery time	t _{rr}	-	13	-	ns	$V_{\rm R}$ =20 V, $I_{\rm F}$ =9.6 A, d $I_{\rm F}$ /d t =100 A/ μ s	
Reverse recovery charge	$Q_{\rm rr}$	-	4.3	-	nC	V_{R} =20 V, I_{F} =9.6 A, d I_{F} /d t =100 A/ μ s	

⁹⁾ Defined by design. Not subject to production test.

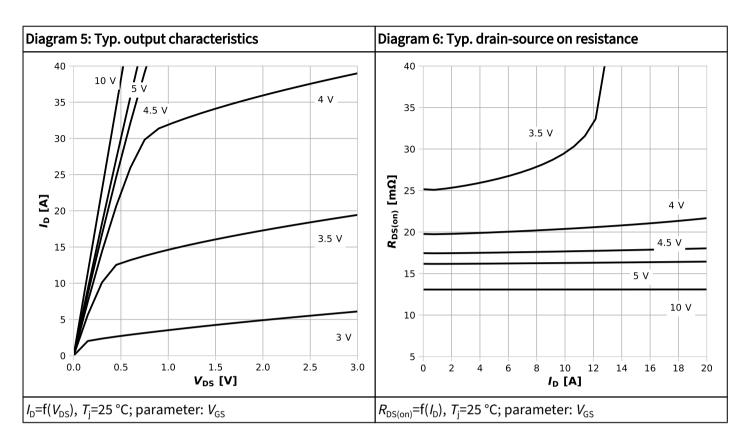


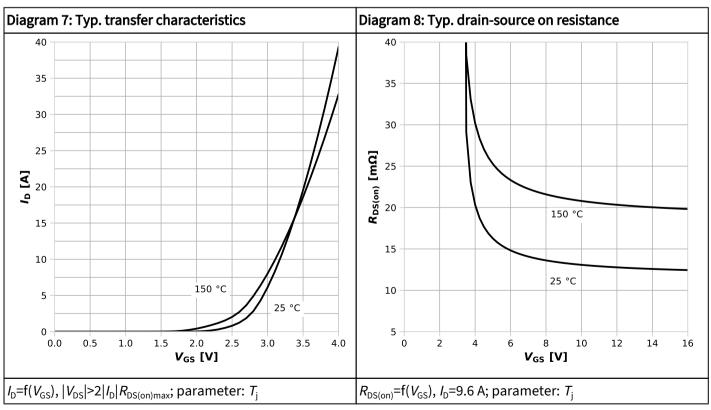
4 Electrical characteristics diagrams



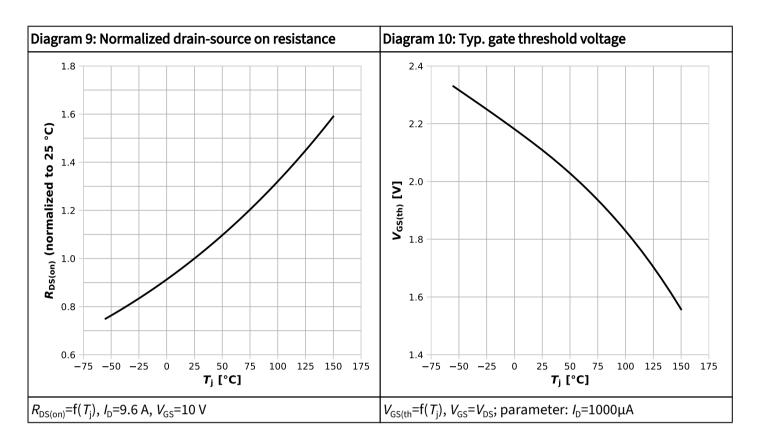


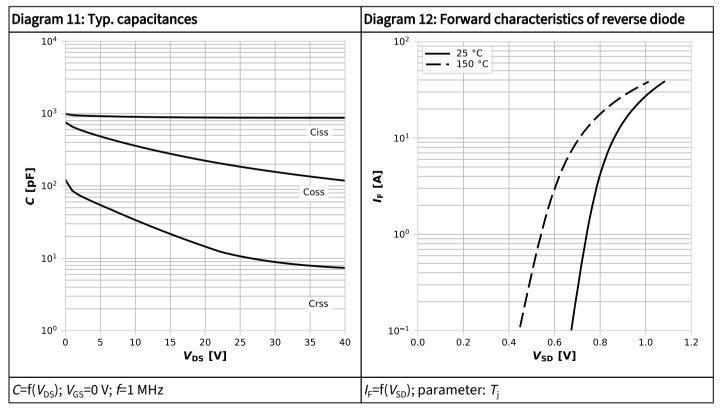




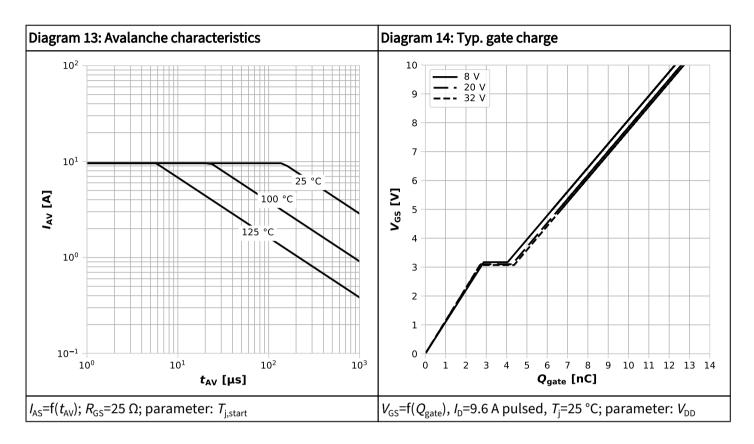


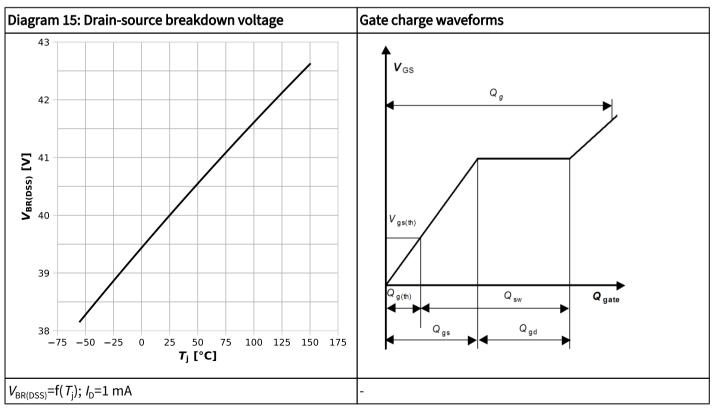






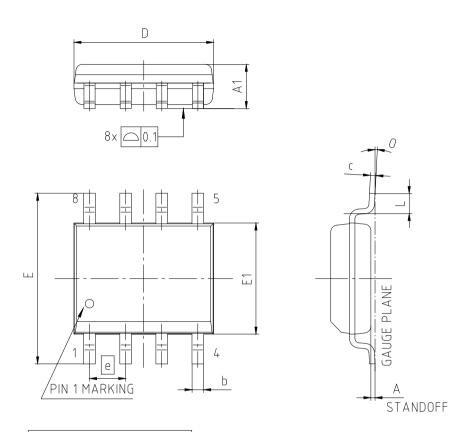








5 Package Outlines



PACKAGE - GROUP NUMBER:	PG-DS	PG-DSO-8-U02						
DIMENSIONS	MILLIMETERS							
DIMENSIONS	MIN.	MAX.						
Α	0.18	0.25						
A1	1.35	1.75						
b	0.38	0.51						
С	0.254							
D	4.80	5.00						
E	5.80	6.20						
E1	3.80	4.00						
е	1.27							
L	0.48	0.91						
0	4°							
N		3						

NOTE:

DIMENSIONS DO NOT INCLUDE MOLD FLASH, PROTRUSION OR GATE BURRS

Figure 1 Outline PG-DSO-8, dimensions in mm

OptiMOS™ 3 Power-Transistor, 40 V ISA170170N04LMDS



Revision History

ISA170170N04LMDS

Revision 2024-10-02, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2024-10-02	Release of final datasheet

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